# 502638935 01/16/2014

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2

EPAS ID: PAT2685543

NATURE OF CONVEYANCE: ASSIGNMENT	SUBMISSION TYPE:	NEW ASSIGNMENT
,	NATURE OF CONVEYANCE:	ASSIGNMENT

# **CONVEYING PARTY DATA**

Name	Execution Date
JINWAN BAE	11/27/2013
HYUNGGON RYU	11/27/2013

### RECEIVING PARTY DATA

Name:	LG ELECTRONICS INC.	
Street Address:	20 YEOUIDO-DONG YEONGDEUNGPO-GU	
City:	SEOUL	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	150-721	

# PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29479449

# CORRESPONDENCE DATA

 Fax Number:
 (202)739-3001

 Phone:
 202.739.3000

Email: patents@morganlewis.com, ateckman@morganlewis.com

Correspondence will be sent via US Mail when the email attempt is unsuccessful.

Correspondent Name: ROBERT J. GAYBRICK

Address Line 1: 1111 PENNSYLVANIA AVE, NW

Address Line 4: WASHINGTON, DISTRICT OF COLUMBIA 20004

ATTORNEY DOCKET NUMBER:	001082-7294
NAME OF SUBMITTER:	ROBERT J. GOODELL
Signature:	/Robert J. Goodell/
Date:	01/16/2014

Total Attachments: 1 source=2#page1.tif

PATENT REEL: 031986 FRAME: 0008

Morgan, Lewis & Backius LLP U.S. Patent & Frademark Office Substitute Form PTO/SB/01 (09-2012)

ATTORNEY DOCKET NO.: SOLE/JOINT INVENTION
(U.S. Rights Only)

#### ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

#### MOBILE PHONE CASE

for which I/WE executed an application for United States Letters Patent	concurrently herewith; or filed ar
application for United States Letters Patent on, (Application No,	); and

WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Scoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

and Power of Attorney in this application,	nd request the attorneys I/WE have empowered to insert here in parenthesis (Application No	filed
	ation number of said application when known.	
IN TESTIMONY WHEREOF, I/V	VE have hereunto set our hand(s).	
Full Name of First Assignor Jinwan BAE	Assignor's Signature	Date (1,2013
Address 2nd floor, 3-155 Jongam-doi	ng, Seongbuk-gu, Seoul, Korea	Citizenship Republic of Korea
Full Name of Second Assignor Hyunggon RYU	Assignor's Signature	Date 11.20.2013
	58-3 Yeongtong-dong, Yeongtong-gu, orea	Citizenship Republic of Korea
Names of additional inventors attached Ye		

iw.oae/비전원/10.127 100 : 70/2015 11-27 1802